

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Kenji KAWAI et. al

Application No.: 10/594,057

Confirmation No.: 8885

Filed: June 25, 2007

Art Unit: 1782

For: HEAT-SEALABLE LAYERED  
POLYPROPYLENE RESIN FILM AND  
PACKAGE

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Examiner: Michele Lynn Jacobson

**STATEMENT OF SUBSTANCE OF INTERVIEW**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Examiner's Interview conducted on February 3, 2012, Applicants submit the following summary of the interview.

During the telephonic interview, Ms. Crystal Downs, on behalf of the undersigned attorney, informed the Examiner that the IDS filed April 6, 2011, had not been considered, and requested that it be considered by the Examiner. We have since received the signed copy of the SB08 from the Examiner and the undersigned attorney thanks the Examiner for his attention to this matter.

Dated: February 10, 2012

Respectfully submitted,

By   
Takamitsu Fujiu

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